600V, 30A, Trench FS II Fast IGBT

General Description:

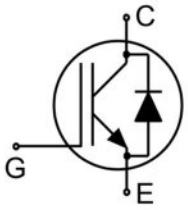
Using MJ's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

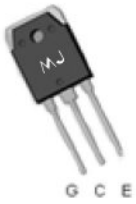
- ◆ Trench FSII Technology offering
- ◆ Very low $V_{CE\ (sat)}$
- ◆ High speed switching
- ◆ Positive temperature coefficient in $V_{CE\ (sat)}$
- ◆ Very tight parameter distribution
- ◆ High ruggedness, temperature stable behavior

Application

- ◆ Air Condition
- ◆ Inverters
- ◆ Motor drives



Schematic diagram



TO-3PNT

Package Marking and Ordering Information

Device	Device Package	Device Marking
MJ30TH60BP	TO-3PNT	MJ30TH60BP

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Parameter	Symbol	Value	Units
Collector-Emitter Voltage	V_{CES}	600	V
Gate- Emitter Voltage	V_{GES}	±30	V
Collector Current	I_C	60	A
Collector Current @T_C = 100 °C	I_C	30	A
Pulsed Collector Current, t_p limited by T_{jmax}	I_{Cplus}	90	A
turn off safe operating area, V_{CE}=600V, Tj=150°C	-	90	A
Diode Continuous Forward Current @T_C = 100 °C	I_F	15	A
Diode Maximum Forward Current	I_{FM}	45	A
Power Dissipation @ T_C = 25°C	P_D	190	W
Power Dissipation @T_C = 100 °C	P_D	95	W
Operating Junction and Storage Temperature Range	T_J,T_{stg}	-55 to +175	℃
Maximum Temperature for Soldering	T_L	260	℃
Short circuit withstand time V_{GE}=15.0V, V_{CC}≤400V, Allowed number of short circuits<1000Time between short circuits:≥1.0s,Tj≤150°C	t_{sc}	5	us

Thermal Characteristic

Parameter	Symbol	Value	Units
Thermal Resistance, Junction to case for IGBT	$R_{\theta JC}$	0.78	°C/W
Thermal Resistance, Junction to case for Diode	$R_{\theta JC}$	1.08	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	40	°C/W

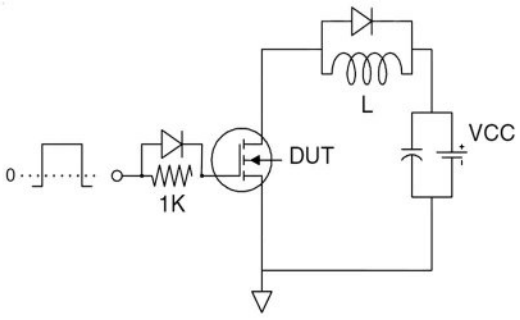
Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions		Value Min	Value Typ	Value Max	Units
Static Characteristics							
Collector-Emitter Breakdown Voltage	$V_{(BR)CES}$	V_{GE}=0V,I_{CE}=1mA		600	-	-	V
Collector-Emitter Leakage Current	I_{CES}	V_{GE}=0V,V_{CE}=600V		-	-	4	uA
Gate to Emitter Forward Leakage	$I_{GES(F)}$	V_{GE}=+30V,V_{CE}=0V		-	-	200	nA
Gate to Source Reverse Leakage	$I_{GES(R)}$	V_{GE}=-30V,V_{CE}=0V		-	-	200	nA
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	I_C=30A V_{GE}=15V	Tj=25°C	-	1.7	1.9	V
			Tj=150°C	-	1.9	-	V
Gate Threshold Voltage	$V_{GE(th)}$	I_C=1mA, V_{CE}=V_{GE}		4.0	5.0	6.0	V
Dynamic Characteristics							
Input Capacitance	C_{ies}	V_{CE}=25V,V_{GE}=0V, f=1MHz		-	3552	-	pF
Output Capacitance	C_{oss}			-	106	-	pF
Reverse Transfer Capacitance	C_{rss}			-	67	-	pF
Gate Charge	Q_{Gate}	V_{CC}=480V, I_C=30A V_{GE}=15V		-	132	-	nC
Gate to Emitter Charge	Q_{ge}			-	28	-	nC
Gate to Collector Charge	Q_{gc}			-	54	-	nC
Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	$I_{C(SC)}$	V_{GE}=15V,V_{CC}≤400V, t_{SC}≤5us,T_j≤150°C		-	190	-	A
Switching Characteristics							
Turn-on Delay Time	$t_{d(ON)}$	V_{CC}=400V,I_C=30A V_{GE}=0/15V, R_g=5Ω Inductive Load		-	19	-	ns
Rise Time	t_r			-	17	-	ns
Turn-Off Delay Time	$t_{d(OFF)}$			-	166	-	ns
Fall Time	t_f			-	16	-	ns
Turn-On Switching Loss	E_{on}			-	0.36	-	mJ
Turn-Off Switching Loss	E_{off}			-	0.32	-	mJ
Total Switching Loss	E_{ts}			-	0.68	-	mJ

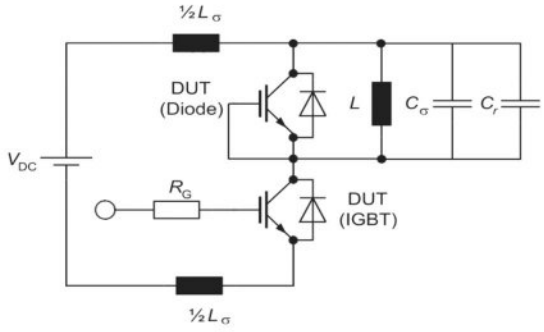
Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified):

Parameter	Symbol	Test Conditions	Rating			Units
			Min	Typ	Max	
Diode Forward Voltage	V_{FM}	I_F=15A	-	1.7	1.9	V
Reverse Recovery Time	T_{rr}	I_F=15A, di/dt=200A/uS	-	178	-	ns
Diode Peak Reverse Recovery Current	I_{RRM}		-	4	-	A
Reverse Recovery Charge	Q_{rr}		-	0.4	-	uC
Pulse width ttp≤380μs,δ≤2%						

Test Circuit

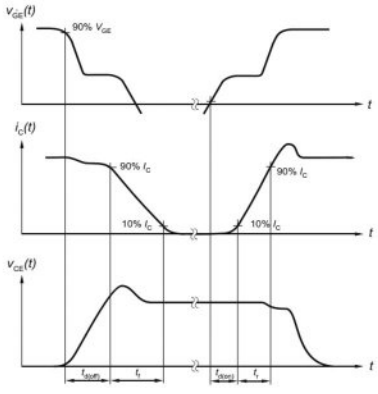


Gate Charge Test Circuit

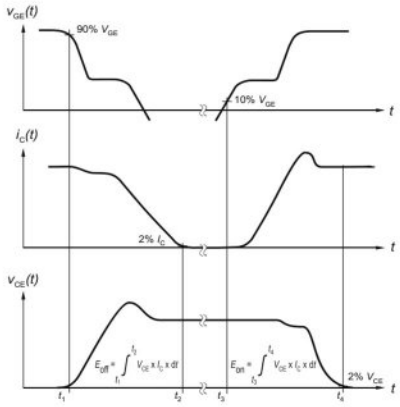


Switch Time Test Circuit

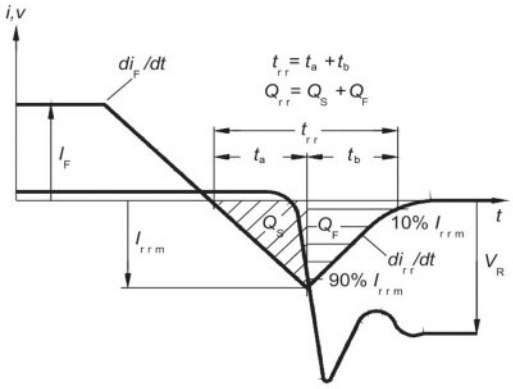
Switching characteristics



definition of switching times



definition of switching losses



Definition of diode switching characteristics

Typical Electrical and Thermal Characteristics

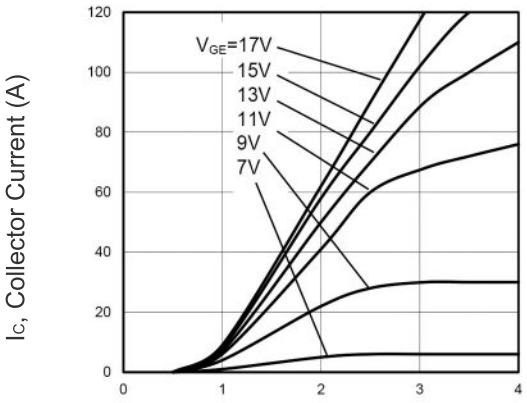


Figure 1 Output Characteristics

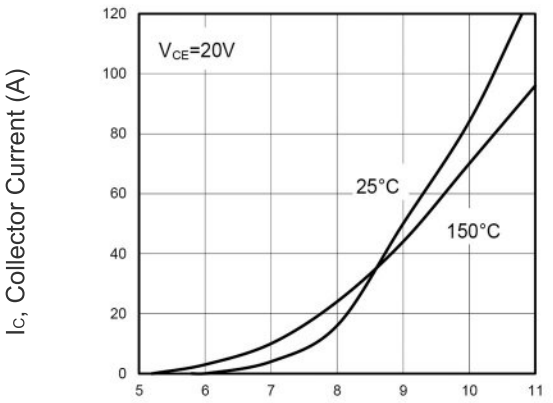


Figure 2 Transfer Characteristics

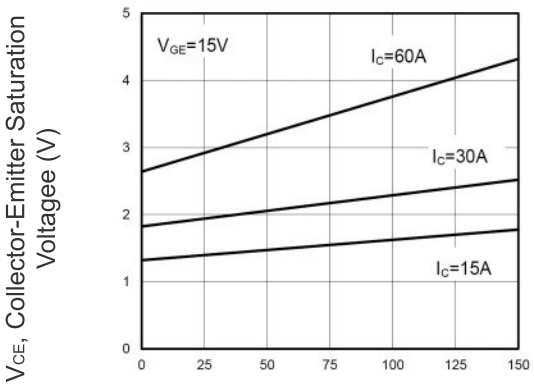


Figure 3 V_{CEsat} vs. Case Temperature

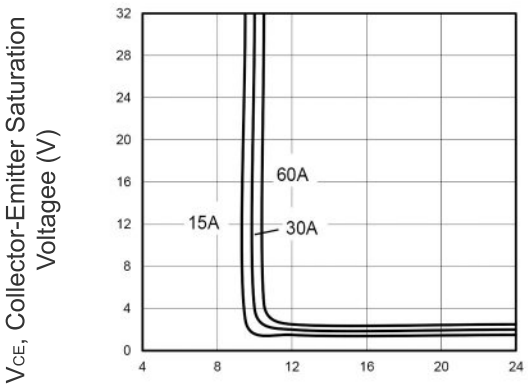


Figure 4 Saturation Voltage vs. V_{GE}

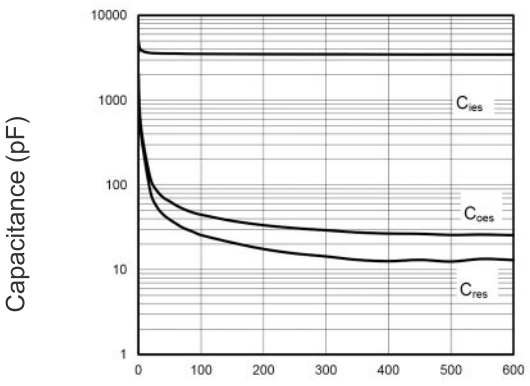


Figure 5 Capacitance Characteristics

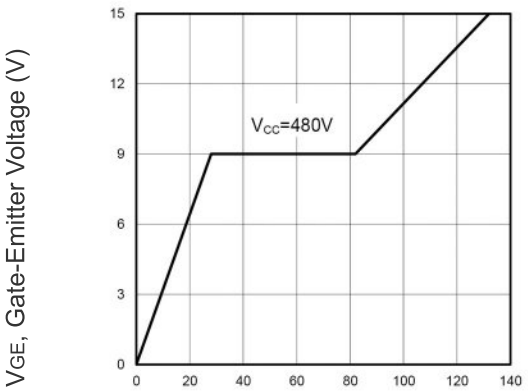
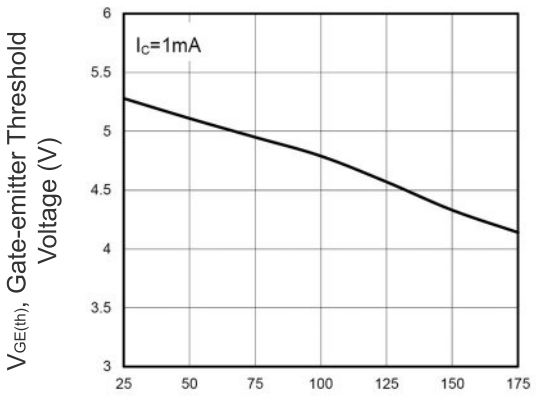


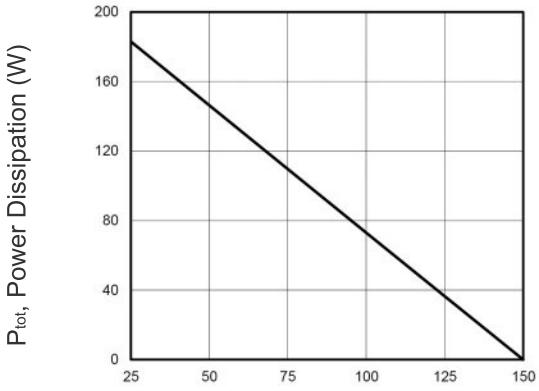
Figure 6 Gate charge waveform

Typical Electrical and Thermal Characteristics



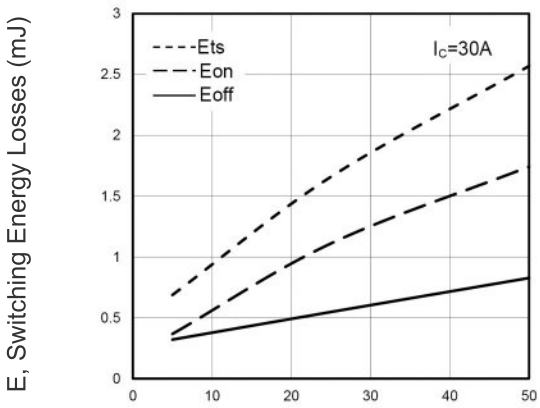
T_J, Junction Temperature (°C)

Figure 7 Gate-emitter Threshold Voltage as a Function of Junction Temperature



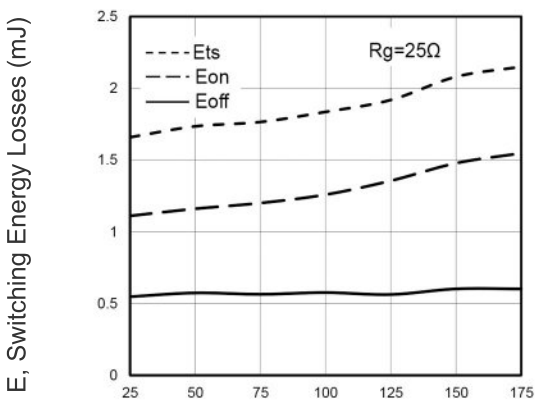
T_C, Case Temperature (°C)

Figure 8 Power Dissipation as a Function of Case Temperature



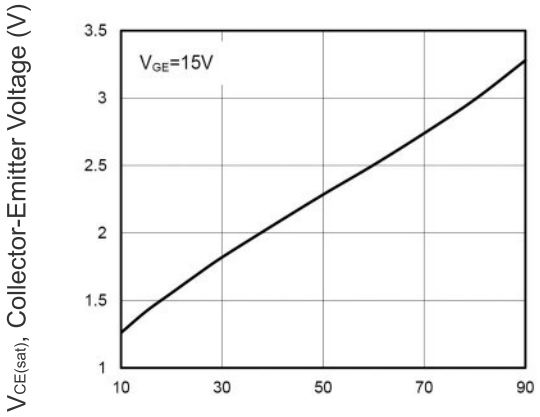
R_G, Gate Resistor (Ω)

Figure 9 Typical Switching Times as a Function of Gate Resistor



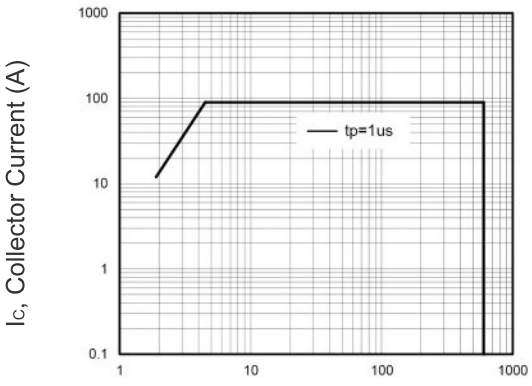
T_J, Junction Temperature (°C)

Figure 10 Typical Switching Times as a Function of Junction Temperature



I_C, Collector Current (A)

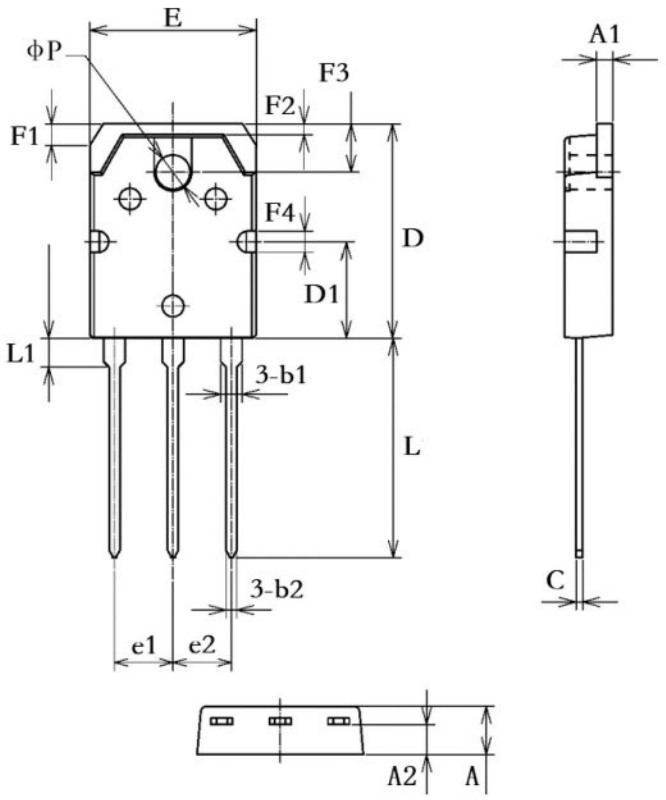
Figure 11 Typical Collector-emitter Saturation Voltage as a function of Collector Current



V_{CE}, Collector-Emitter Voltage (V)

Figure 12 Forward Bias Safe Operating Area

TO-3PNT Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.35	4.65	0.17	0.18
A1	1.40	1.60	0.06	0.06
A2	2.60	3.00	0.10	0.12
b1	1.90	2.30	0.07	0.09
b2	0.90	1.10	0.04	0.04
C	0.50	0.70	0.02	0.03
D	19.70	20.30	0.78	0.80
D1	7.30	7.90	0.29	0.31
E	15.20	15.80	0.60	0.62
e1/e2	5.35	5.55	0.21	0.22
F1	1.50	2.50	0.06	0.10
F2	0.70	1.30	0.03	0.05
F3	4.60	4.90	0.18	0.19
F4	2.10	2.50	0.08	0.10
L	19.50	21.5	0.77	0.85
L1	2.10	3.30	0.08	0.13
ΦP	3.00	3.40	0.12	0.13

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